



IN THE <u>UNITED STATES PATENT AND TRADEMARK OFFICE</u>

Applicant: Kie Y. Ahn et al.

Examiner:

David S. Blum

Serial No.:

09/945,535

Group Art Unit:

2813

Filed:

August 30, 2001

Docket:

1303.026US1

Title:

HIGHLY RELIABLE AMORPHOUS HIGH-K GATE OXIDE ZrO2

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In compliance with the duty imposed by 37 C.F.R. § 1.56, and in accordance with 37 C.F.R. §§ 1.97 et. seq., the enclosed materials are brought to the attention of the Examiner for consideration in connection with the above-identified patent application. Applicants respectfully request that this Supplemental Information Disclosure Statement be entered and the documents listed on the attached Form 1449 be considered by the Examiner and made of record. Pursuant to the provisions of MPEP 609, Applicants request that a copy of the 1449 form, initialed as being considered by the Examiner, be returned to the Applicants with the next official communication.

Pursuant to 37 C.F.R. §1.97(c)(2), Applicants have included the fee of \$180.00 as set forth in 37 C.F.R. §1.17(p). Please charge any additional fees or credit any overpayment to Deposit Account No. 19-0743.

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The Examiner is invited to contact the Applicants' Representative at the below-listed telephone number if there are any questions regarding this communication.

Pursuant to 37 C.F.R. 1.98(a)(2), Applicant believes that copies of cited U.S. Patents and Published Applications are no longer required to be provided to the Office. Notification of this change was provided in the United States Patent and Trademark Office OG Notices dated October 12, 2004. Thus, Applicant has not included copies of any US Patents or Published Applications cited with this submission. Should the Office require copies to be provided, Applicant respectfully requests that notice of such requirement be directed to Applicant's below-signed representative. Applicant acknowledges the requirement to submit copies of foreign patent documents and non-patent literature in accordance with 37 C.F.R. 1.98(a)(2).

Respectfully submitted,

KIE Y. AHN ET AL.

By their Representatives,

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Date June 7, 2005 A

Suneel Arora

Reg. No. 42,267

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 4 day of June, 2005.

Name KACIA LEE

Vacia Lee

PTO/SB/08A(10-01)
Approved for use through 10/31/2002. OMB 051-0031
US Patent & Trademark Office: U.S. DEPARTMENT OF COMMERCE.
Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE **Application Number** 09/945,535 STATEMENT BY APPLICANT August 30, 2001 (Use as many sheets as necessary) **Filing Date** Ahn, Kie **First Named Inventor** Group Art Unit 2813 Blum, David **Examiner Name** JUN 1 3 2005 Attorney Docket No: 1303.026US1 Sheet 1 of 3

US PATENT DOCUMENTS				
Examiner Initial *	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Filing Date If Appropriate
	US-2001/0030352-A1	10/18/2001	Ruff, Alexander , et al.	02/28/2001
	US-2002/0111001-A1	08/15/2002	Ahn, Kie Y.	02/09/2001
	US-2002/0155688-A1	10/24/2002	Ahn, Kie Y.	04/20/2001
	US-2002/0155689-A1	10/24/2002	Ahn, Kie Y.	02/11/2002
	US-2002/0192975-A1	12/19/2002	Ahn, Kie Y.	06/17/2002
	US-2002/0192979-A1	12/19/2002	Ahn, Kie Y.	06/17/2002
	US-2003/0003702-A1	01/02/2003	Ahn, Kie Y.	08/26/2002
	US-2003/0017717-A1	01/23/2003	Ahn, Kie Y.	07/18/2001
	US-2003/0043637-A1	03/06/2003	Forbes, Leonard, et al.	08/30/2001
	US-2003/0045060-A1	03/06/2003	Ahn, Kie Y.	08/30/2001
	US-2003/0049942-A1	03/13/2003	Haukka, S., et al.	08/22/2002
	US-2003/0119246-A1	06/26/2003	Ahn, Kie Y.	12/20/2001
	US-2003/0119291-A1	06/26/2003	Ahn, Kie Y., et al.	12/20/2001
	US-2003/0132491-A1	07/17/2003	Ahn, Kie Y.	01/17/2002
	US-2003/0185980-A1	10/02/2003	Endo, K.	03/31/2003
	US-2003/0207032-A1	11/06/2003	Ahn, Kie Y., et al.	05/02/2002
	US-2003/0207540-A1	11/06/2003	Ahn, Kie Y., et al.	05/02/2002
	US-2003/0227033-A1	12/11/2003	Ahn, Kie Y., et al.	06/05/2002
	US-2004/0007171-A1	01/15/2004	Ritala, Mikko, et al.	07/10/2003
_	US-2004/0009679-A1	01/15/2004	Yeo, J., et al.	07/10/2003
	US-2004/0023461-A1	02/05/2004	Ahn, Kie Y., et al.	07/30/2002
	US-2004/0033661-A1	02/19/2004	Yeo, J., et al.	06/02/2003
	US-2004/0038554-A1	02/26/2004	Ahn, Kie Y.	08/21/2002
	US-2004/0043541-A1	03/04/2004	Ahn, Kie Y.	08/29/2002
	US-2004/0043569-A1	03/04/2004	Ahn, Kie Y.	08/28/2002
	US-2004/0110348-A1	06/10/2004	Ahn, Kie Y., et al.	12/04/2002
	US-2004/0110391-A1	06/10/2004	Ahn, K. Y., et al.	12/04/2002
	US-2004/0134365-A1	08/26/2004	Ahn, Kie Y., et al.	02/27/2004
	US-2004/0144980-A1	07/29/2004	Ahn, Kie Y., et al.	01/29/2003
	US-2004/0164357-A1	08/26/2004	Ahn, Kie Y., et al.	02/27/2004
	US-2004/0168627-A1	09/02/2004	Conley, Jr., J. F., et al.	02/27/2003
	US-2004/0171280-A1	09/02/2004	Conley, Jr., J. F., et al.	02/27/2003
	US-2004/0175882-A1	09/09/2004	Ahn, Kie Y., et al.	03/04/2003
	US-2004/0183108-A1	09/23/2004	Ahn, Kie Y.	01/27/2004
	US-2004/0185654-A1	09/23/2004	Ahn, Kie Y.	01/30/2004
	US-2004/0203254-A1	10/14/2004	Conley, Jr., J. F., et al.	04/11/2003
	US-2004/0235313-A1	11/25/2004	Frank, M. M., et al.	06/24/2004
	US-2004/0266217-A1	12/30/2004	Kim, K., et al.	06/23/2004
	US-2005/0009370-A1	01/13/2005	Ahn, Kie Y.	08/04/2004
	US-2005/0023578-A1	02/03/2005	Bhattacharyya, A.	08/25/2004

EXAMINER

PTO/SB/08A(10-01)
Approved for use through 10/31/2020. OMB 551-0031
US Patent & Trademert Office: U.S. DEPARTMENT OF COMMERCE
Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number, Substitute for form 1449A/PTO Complete if Known INFORMATION DISCLOSURE 09/945,535 **Application Number** STATEMENT BY APPLICANT August 30, 2001 Filing Date (Use as many sheets as p Ahn, Kie **First Named Inventor** 2813 **Group Art Unit** JUN 1 3 2005 Blum, David **Examiner Name** Attorney Docket No: 1303.026US1 Sheet 2 of 3

US-2005/0023594-A1	02/03/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0023613-A1	02/03/2005	Bhattacharyya, A.	08/25/2004
US-2005/0023624-A1	02/03/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0023625-A1	02/03/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0023626-A1	02/03/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0023627-A1	02/03/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0026374-A1	02/03/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0029547-A1	02/10/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0029604-A1	02/21/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0029605-A1	02/10/2005	Ahn, K Y., et al.	08/31/2004
US-2005/0032292-A1	02/10/2005	Ahn, K. Y., et al.	08/31/2004
US-2005/0037563-A1	02/17/2005	Ahn, Kie Y.	08/31/2004
 US-2005/0051828-A1	03/10/2005	Park, K., et al.	04/21/2004
US-2005/0054165-A1	03/10/2005	Ahn, K. Y., et al.	03/31/2003
US-2005/0077519-A1	04/14/2005	Ahn, Kie, et al.	10/10/2003
US-5,562,952	10/08/1996	Nakahigashi, Takahiro , et al.	04/04/1995
US-5,646,583	07/08/1997	Seabury, C. W., et al.	01/04/1996
US-5,674,563	10/07/1997	Tarui, Yasuo , et al.	09/14/1994
 US-5,751,021	05/12/1998	Teraguchi, Nobuaki	04/22/1996
US-5,827,571	10/27/1998	Lee, Seaung S., et al.	09/17/1997
 US-6,632,279	10/14/2003	Ritala, M., et al.	10/13/2000
 US-6,686,212	02/03/2004	Conley, Jr., J. F., et al.	10/31/2002
 US-6,699,747	03/02/2004	Ruff, Alexander , et al.	11/18/2002
 US-6,709,989	03/23/2004	Ramdani, J., et al.	06/21/2001
 US-6,777,353	08/17/2004	Putkonen, M.	04/08/2003
 US-6,787,413	09/07/2004	Ahn, Kie Y.	06/17/2002
 US-6,790,791	09/14/2004	Ahn, Kie Y., et al.	08/15/2002
 US-6,812,100	11/02/2004	Ahn, K. Y., et al.	03/13/2002
 US-6,828,632	12/07/2004	Bhattacharyya, A.	07/18/2002
 US-6,884,739	04/26/2005	Ahn, K. Y., et al.	08/15/2002
 US-6,893,984	05/17/2005	Ahn, K. Y., et al.	02/20/2002
US-6,900,122	05/31/2005	Ahn, K. Y., et al.	12/20/2001

FOREIGN PATENT DOCUMENTS				
Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	T²
	WO-04079796A3	09/16/2004	Ahn, K. Y., et al.	

EXAMINER

PTO/SB/08A(10-01)
Approved for use through 103/1/2002. OMB 651-0031
US Patient & Trademark Office: U.S. DEPARTMENT OF COMMERCE
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		R DOCUMENTS NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
		CHIN, A., et al., "High Quality La2O3 and Al2O3 Gate Dielectrics with	
		Equivalent Oxide Thickness 5-10A", Digest of Technical Papers, 2000	
		Symposium on VLSI Technology, 2000, Honolulu, (June 13-15, 2000), 16-17	
		COPEL, M., et al., "Formation of a stratified lanthanum silicate dielectric by	
		reaction with Si(001)", <u>Applied Physics Letters</u> , 78(11), (March 12, 2001), 1607-	
		DIMOULAS, A., et al., "Structural and electrical quality of the high-k dielectric	
		Y2O3 on Si (001): Dependence on growth parameters", <u>Journal of Applied Physics</u> , 92(1), (July 1, 2002), 426-431	
		GUHA, S, et al., "Atomic beam deposition of lanthanum-and yttrium-based oxide thin films for gate dielectrics", Applied Physics Letters, 77, (2000), 2710-2712	
		GUHA, S., et al., "High temperature stability of Al2O3 dielectrics on Si:	
		Interfacial metal diffusion and mobility degradation", <u>Applied Physics Letters, Vol.</u> 81, No. 16, (14 October 2002), 2956-2958	
		HUANG, C. H., et al., "La/sub 2/O/sub 3//Si/sub 0.3/Ge/sub 0.7/ p-MOSFETs	
		with high hole mobility and good device characteristics", <u>IEEE Electron Device</u> <u>Letters, 23(12),</u> (December 2002), 710-712	
		IWAI, H., et al., "Advanced gate dielectric materials for sub-100 nm CMOS",	
•		International Electron Devices Meeting, 2002. IEDM '02. Digest., (December 8-11, 2002), 625-628	
		KO, MYOUNG-GYUN, et al., "High density plasma enhanced atomic layer	
		deposition of lanthanum oxide for high-k gate oxide material", 207th Meeting of the Electrochemical Society, (May 2005), 1 page	
		MARIA, J. P., et al., "High temperature stability in lanthanum and zirconia-based	
		gate dielectrics", <u>Journal of Applied Physics</u> , 90(7), (October 1, 2001), 3476-3482	
	· · · · · · · · · · · · · · · · · · ·	MICHAELSON, HERBERT B., "The work function of the elements and its	
		periodicity", Journal of Applied Physics, 48(11), (November 1977), 4729-4733	
		SHIMIZU, TAKASHI, et al., "Electrical Properties of Ruthenium/Metalorganic	
		Chemical Vapor Deposited La-Oxide/Si Field Effect Transistors", Jpn. J. Appl.	
		Phys., Vol. 42, Part 2, No. 11A, (2003), L1315-L1317	
		YAMADA, HIROTOSHI, et al., "MOCVD of High-Dielectric-Constant Lanthanum	
		Oxide Thin Films", Journal of The Electrochemical Society, 150(8), (August	
		2003), G429-G435	
		ZHONG, HUICAI, et al., "Electrical Properties of Ru and RuO2 Gate Electrodes	
		for Si-PMOSFET with ZrO2 and Zr-Silicate Dielectrics", Journal of Electronic	
		Materials, 30(12), (December 2001), 1493	

EXAMINER

DATE CONSIDERED

S/N 09/945,535 PATENT

IN THE COUTED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. Ahn et al. Examiner: David S. Blum

Serial No.: 09/945,535 Group Art Unit: 2813

Filed: August 30, 2001 Docket: 1303.026US1

Title: HIGHLY RELIABLE AMORPHOUS HIGH-K GATE OXIDE ZRO2

COMMUNICATION CONCERNING RELATED APPLICATION(S)

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicants would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

Serial/Patent No. 10/909959	Filing Date August 2, 2004	Attorney Docket 1303.114US1	Title ATOMIC LAYER DEPOSITION OF ZIRCONIUM-DOPED TANTALUM OXIDE FILMS
10/931533	August 31, 2004	1303.119US1	ATOMIC LAYER DEPOSITED TITANIUM ALUMINUM OXIDE FILMS
10/926812	August 26, 2004	1303.121US1	RUTHENIUM GATE FOR A LANTHANIDE OXIDE DIELECTRIC LAYER
10/930167	August 31, 2004	1303.122US1	ATOMIC LAYER DEPOSITED LANTHANUM ALUMINUM OXIDE DIELECTRIC LAYER
11/010529	December 13, 2004	1303.126US1	ATOMIC LAYER DEPOSITED LANTHANUM HAFNIUM OXIDE DIELECTRICS
11/029757	January 5, 2005	1303.127US1	ATOMIC LAYER DEPOSITED HAFNIUM TANTALUM OXIDE DIELECTRICS
11/010766	December 13, 2004	1303.129US1	HYBRID ALD-CVD OF PrXOY/ZrO2 FILMS AS GATE DIELECTRICS
11/058563	February 15, 2005	1303.133US1	ATOMIC LAYER DEPOSITION OF Zr3N4/ZrO2 FILMS AS GATE DIELECTRICS

Serial Number: 09/945,535 Filing Date: August 30, 2001

Title: HIGHLY RELIABLE AMORPHOUS HIGH-K GATE OXIDE ZRO2

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- 11/063717	February 23, 2005	1303.134US1	ATOMIC LAYER DEPOSITION OF Hf3N4/HfO2 FILMS AS GATE DIELECTRICS
11/059594	February 16, 2005	1303.046US2	EVAPORATED LaAlO3 FILMS FOR GATE DIELECTRICS
11/092072	March 29, 2005	1303.135US1	ALD OF AMORPHOUS LANTHANIDE DOPED TIOX FILMS
11/093104	March 29, 2005	1303.136US1	ATOMIC LAYER DEPOSITED TITANIUM SILICON OXIDE FILMS
11/117121	April 28, 2005	1303.138US1	ATOMIC LAYER DEPOSITED ZIRCONIUM SILICON OXIDE FILMS
11/117125	April 28, 2005	1303.139US1	ATOMIC LAYER DEPOSITION OF A RUTHENIUM LAYER TO A LANTHANIDE OXIDE DIELECTRIC LAYER
11/084968	March 21, 2005	1303.083US2	Zr-Sn-Ti-O FILMS

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicant requests that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted, KIE Y. AHN ET AL.

By Applicants' Representatives, SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. P.O. Box 2938

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Name KACIA LEE

Signature Zee